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 Toshiko YOKOTA Tetsuhiro MATSUNAGA Susumu TAKAHASHI Hideaki MATSUSHIMA Takuya YAMAMOTO Makoto DOBASHI 	NAME: MITSUI MINING AND SMELTING CO., LTD. ADDRESS: 11-1, Osaki 1-chome, Shinagawa-ku Tokyo 141-8584, Japan
Execution Date(s):1-4 & 6 8/26/05; 5. 9/13/05	
Additional name(s) of conveying party(ies) attached? Yes X No	Additional name(s) & addresses(es) attached?
3. Name of Conveyance:	
Assignment	
4. Application number(s) or patent number(s):	This document is being filed together with a new application
A. Patent Application No.(s)	B. Patent No.(s)
10/532,717	
Additional numbers attached? Yes X No	
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Robert B. Murray Address: Rothwell, Figg, Ernst & Manbeck Suite 800 Street Address: 1425 K St., N.W. City: Washington, State: D.C. Zip: 20005	7. Total fee (37 CFR 3.41): \$ _40
Telephone No.: 202/783-6040 Facsimile No.: 202/783-6031 Email Address:	8. Deposit account number: 02-2135
Attorney Docket No. :3209-104	Authorized User Name <u>Robert B. Murray</u>
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9. Signature. Signature Robert B. Murray Total number of Power Signing	September 29, 2005 Date pages including cover sheet, attachments and documents: 2

PATENT

700214304

REEL: 016847 FRAME: 0165

ROTHWELL, FIGG, ERNST & MANBECK Docket No: 3209-104

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by:

Mitsui Mining and Smelting Co., Ltd. 11-1, Osaki 1-chome, Sinagawa-ku Tokyo 141-8584, Japan

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled:

COPPER FOIL PROVIDED WITH DIELECTRIC LAYER FOR FORMING CAPACITOR LAYER, COPPER CLAD LAMINATE FOR FORMING THE CAPACITOR LAYER USING THE COPPER FOIL PROVIDED WITH THE DIELECTRIC LAYER, AND METHOD FOR MANUFACTURING THE COPPER FOIL PROVIDED WITH THE DIELECTRIC LAYER FOR FORMING THE CAPACITOR LAYER

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

*filed on October 29, 2005, International No. PCT/JP2003/013818

(Rothwell, Figg, Ernst & Manbeck is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

ASSIGNOR agrees to execute all papers necessary in connection with application and any continuing, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as ASSIGNEE may deem necessary or expedient.

ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, division, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventors have affixed their signatures.

Toshiko YOKOTA

Tetsuhiro MATSUNAGA

Susumu TAKAHASHI

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(SIGNATURE)

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cumu Takahashi

(SIGNATURE) hi *Makuash*a

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(SIGNATURE)

 $\frac{\frac{03}{26}}{\frac{03}{26}}$ (DATE)

08/26/2005

(DATE)

(DATE)

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08/26/2005 (DATE)

NO LEGALIZATION REQUIRED

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RECORDED: 09/29/2005